

**PATENT** 

Docket No. JCLA10543

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## IN THE UNITED STATE PATENT AND TRADEMARK OFFICE

In re Application of : TSUNG-MING PAI et al.

Application No.

: 10/789,171

Filed

: February 26,2004

**Certificate of Mailing** 

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For

: FABRICATING PROCESS THEREOF

Jiawei Huang, Reg. No. 43,330

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Transmitted herewith is a certified copy of Taiwan Application No. 92104000 filed on February 26, 2003.

A return prepaid postcard is also included herewith.

It is believed no fee is due. However, the Commissioner is authorized to charge any fees required, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 50-0710 (Order No. JCLA10543).

Date: 7/19/2004

Registration No. 43,330

Please send future correspondence to:

J. C. Patents 4 Venture, Suite 250 Irvine, California 92618 Tel: (949) 660-0761